

TOSHIBA Photointerrupter Infrared LED + Photo IC

# TLP1037A

Domestic electrical appliances such as VTRs and CD players

Office equipment such as photocopiers, printers and fax machines

Vending machines, bank ATMs and automatic ticket machines

#### Position detectors

The TLP1037A is a high-withstanding-voltage photo-interrupter for digital output. The device combines a high-optical-output GaAs infrared LED with a high-sensitivity, high-gain Si photo-IC. The photo-IC, which supports a wide range of systems (3.3 V to 12 V), enables the device to consume less power than conventional devices. The device also features a narrow slit width and high resolution.

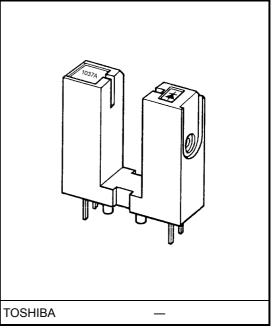
The device is housed in a deep-slot package.

- Deep-slot package (detection slot depth: 12 mm)
- Designed for direct mounting on printed circuit boards (positioning pins included)
- Gap: 5 mm
- Resolution: slit width 0.5 mm
- Digital output (open-collector, high-level output when no light is present)
- Direct connection to logic IC
- Power supply voltage:  $V_{CC} = 2.7 \text{ V} \sim 15 \text{ V}$
- Switching time: tpLH = 15 µs (max)
- Detector impermeable to visible light
- Package material: Polybutylene-terephthalate (UL94V-0, black)

### Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit	
LED	Forward current		١ <sub>F</sub>	50	mA	
	Forward current derating	$(Ta > 25^{\circ}C)$	∆I <sub>F</sub> /°C	-0.33	mA/°C	
		(Ta > 85°C)	AIF/ C	-2		
	Reverse voltage		V <sub>R</sub>	5	V	
Detector	Supply voltage		V <sub>CC</sub>	15	V	
	Output voltage		VO	15	V	
ă	Low-level output current (Ta = T <sub>opr</sub> )		I <sub>OL</sub>	16	mA	
Operat	Operating temperature		T <sub>opr</sub>	-30~95	°C	
Storage temperature		T <sub>stg</sub>	-40~100	°C		
Solder	Soldering temperature (5 s) (Note 1)			T <sub>sol</sub> 260		

Note 1: Soldering is performed 1.5 mm from the bottom of the package.





### **Recommended Operating Conditions**

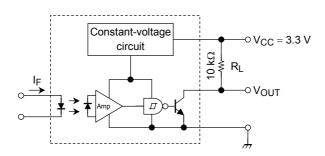
Characteristics	Symbol	Min	Тур.	Max	Unit
LED forward current	lF	8 (Note 2)	_	20	mA
Supply voltage	V <sub>CC</sub>	2.7	3.3	13.2	V
Output voltage	VO	_	_	13.2	V
Low-level output current	I <sub>OL</sub>			16	mA
Operating temperature	T <sub>opr</sub>	-25	_	95	°C

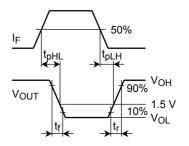
Note 2: The value 8 mA takes account of 50% LED optical fluctuation. The initial value of the threshold input current is 4 mA or less.

## Electrical and Optical Characteristics (unless otherwise specified: Ta = -30~95°C, V<sub>CC</sub> = 2.7~15 V)

Characteristics		Symbol	Test Conditions	Min	Тур.	Max	Unit	
LED	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA, Ta = 25°C	1.00	1.15	1.30	V	
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V, Ta = 25°C		_	10	μA	
	Peak emission wavelength	λ <sub>P</sub>	I <sub>F</sub> = 15 mA, Ta = 25°C		940	_	nm	
Detector	operating supply voltage	V <sub>CC</sub>	—	2.7	_	15	V	
	Low-level supply current	ICCL	I <sub>F</sub> = 15 mA, Ta = 25°C	_	_	1.6	mA	
			I <sub>F</sub> = 15 mA	_	_	2.0		
	High-level supply current	I <sub>ССН</sub>	I <sub>F</sub> = 0	_	_	1.2	mA	
	Low-level output voltage	V <sub>OL</sub>	I <sub>OL</sub> = 16 mA, I <sub>F</sub> = 15 mA, Ta = 25°C	_	0.05	0.3	v	
			I <sub>OL</sub> = 16 mA, I <sub>F</sub> = 15 mA	_	_	0.4		
	High-level output current	I <sub>OH</sub>	$I_F = 0, V_O = 15 V$	_	_	6.3	μA	
	Peak sensitivity wavelength	λP	Ta = 25°C		900	_	nm	
Propagation characteristics	$H \rightarrow L$ threshold input current	IFHL	Ta = 25°C			3	mA	
					_	4	IIIA	
	Hysteresis	I <sub>FHL</sub> /I <sub>FLH</sub>	—		1.5	_		
	Propagation delay time (L $\rightarrow$ H)	t <sub>pLH</sub>	$V_{CC} = 3.3 \text{ V}, \text{ I}_{F} = 15 \text{ mA},$ R <sub>L</sub> = 10 k $\Omega$ , Ta = 25°C (Note 3)	_	_	15	μS	
	Propagation delay time (H $\rightarrow$ L)	t <sub>pHL</sub>				9		
	Rise time	t <sub>r</sub>	$R_{L} = 10 \text{ k}\Omega, \text{ Ta} = 25^{\circ}\text{C}$ (Note 3)		0.8			
	Fall time	t <sub>f</sub>	]	_	0.02			

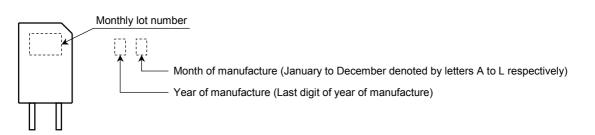








### Markings



### Precautions

- When removing flux with chemicals after soldering, clean only the soldered part of the leads. Do not immerse the entire package in the cleaning solvent. Chemical residue on the LED emitter or the photodetector inside the photo-IC case may adversely affect the optical characteristics of the device and may drastically reduce the threshold input current.
- The case is made of polybutylene-terephthalate. Oil or chemicals may cause the package to melt or crack. Care must be taken in relation to the environment in which the device is to be installed.
- Mount the device on a level surface.
- Output fluctuates for 100 µs after power-on while the internal circuit stabilizes.
- To stabilize the power line, insert a bypass capacitor of up to 0.01 µF between VCC and GND, close to the device.
- The threshold input current increases over time due to current flowing in the infrared LED. The design of circuits which incorporate the device must take into account the change in threshold input current over time. The change in threshold input current is equal to the reciprocal of the change in LED infrared optical output.

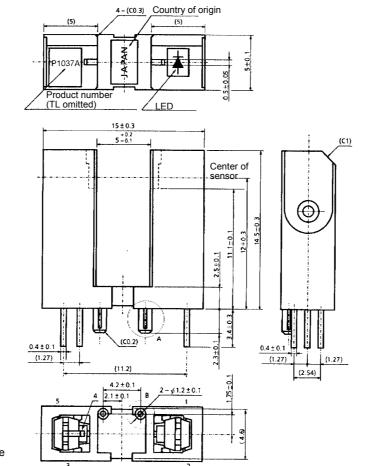
$$\frac{I_{FHL}(t)}{I_{FHL}(0)} = \left(\frac{P_{O}(t)}{P_{O}(0)}\right)^{-1}$$

• Choose a high-quality shutter material which is impermeable to light. If the material is of inferior quality, light from the LED may pass through the shutter, causing the device to malfunction.

### TOSHIBA

Unit: mm

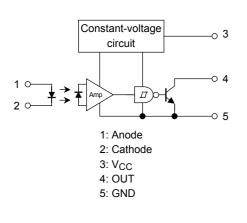
### Package Dimensions

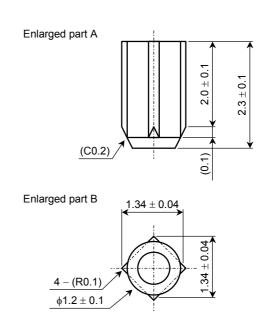


(): reference value

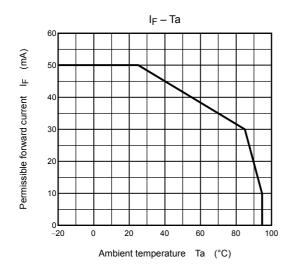
Weight: 1 g (typ.)

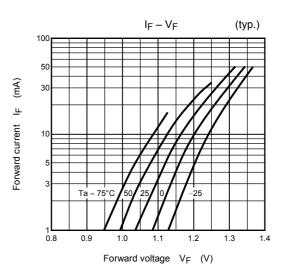
### **Pin Connection**

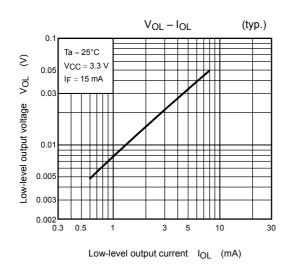


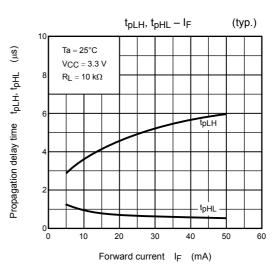


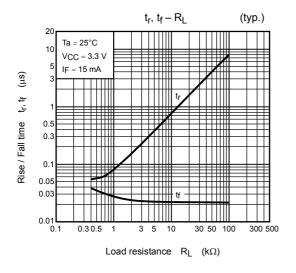
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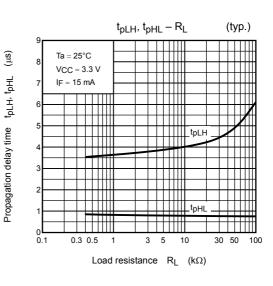


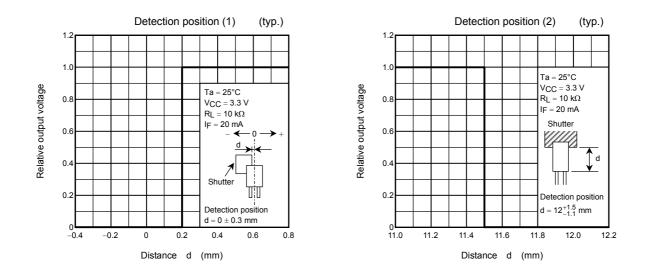






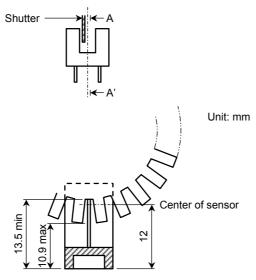






### **Relative Positioning of Shutter and Device**

For normal operation, position the shutter and the device as shown in the figure below. By considering the device's detection direction characteristic and switching time, determine the shutter slit width and pitch.



Cross section between A and A'

#### **RESTRICTIONS ON PRODUCT USE**

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